

NCE N-Channel Enhancement Mode Power MOSFET

Description

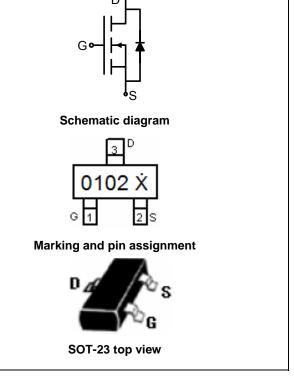
The NCE0102 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 100V, I_D = 2A$ $R_{DS(ON)} < 240m\Omega @ V_{GS} = 10V$ (Typ:195m Ω) $R_{DS(ON)} < 260m\Omega @ V_{GS} = 4.5V$ (Typ:204m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
0102 X	NCE0102	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	I _D	2	A	
Drain Current-Pulsed (Note 1)	I _{DM}	5	A	
Maximum Power Dissipation	PD	1.25	W	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	100	°C/W
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Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V _{GS} =0V I _D =250µA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =100V, V_{GS} =0V	-	-	1	μA



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NCE0102

Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	_	±100	nA
On Characteristics ^(Note 3)	000					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.2	1.8	2.5	V
Davia October October Devictories	R _{DS(ON)}	V _{GS} =10V, I _D =2A	-	195	240	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =2A	-	204	260	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =2A	1	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	360.6	-	PF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V, F=1.0MHz	-	24.6	-	PF
Reverse Transfer Capacitance	Crss		-	13	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	6	-	nS
Turn-on Rise Time	tr	V_{DD} =50V, R _L =25 Ω	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1 Ω	-	12	-	nS
Turn-Off Fall Time	t _f		-	8	-	nS
Total Gate Charge	Qg)/ _==0)// _==2.0	-	12.0		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=50V, I_{D}=2A,$	-	1.8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	2.9	-	nC
Drain-Source Diode Characteristics			·			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =2A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	2	А

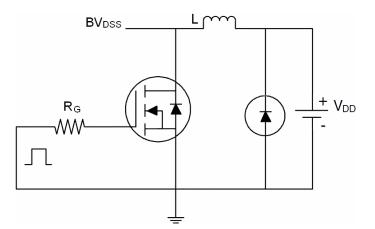
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

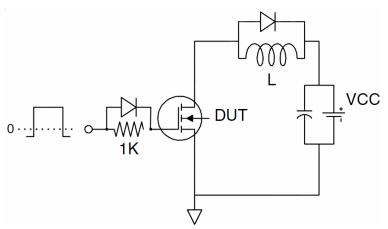


Test Circuit

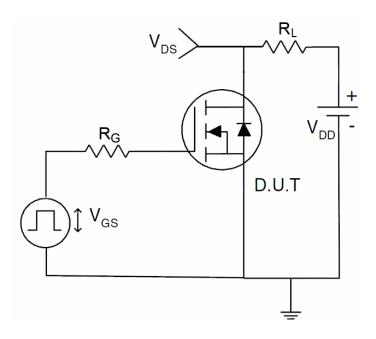
1) E_{AS} test circuit



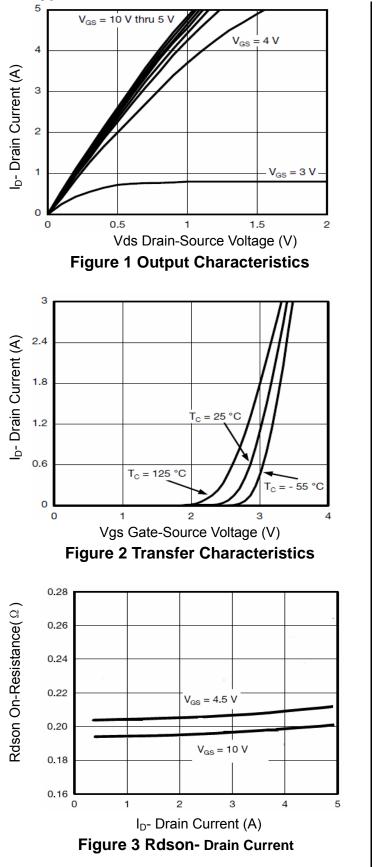
2) Gate charge test circuit



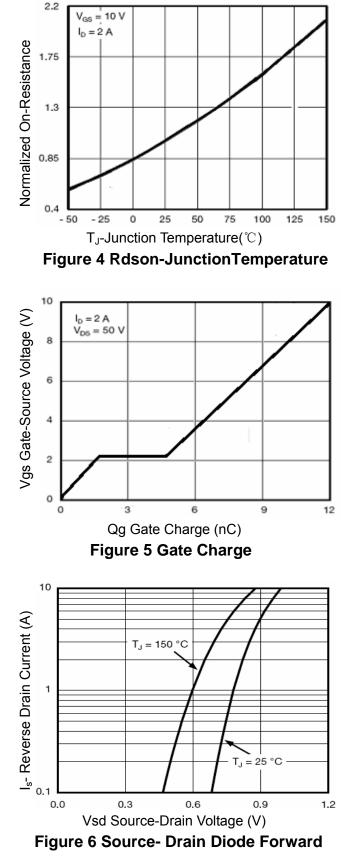
3) Switch Time Test Circuit



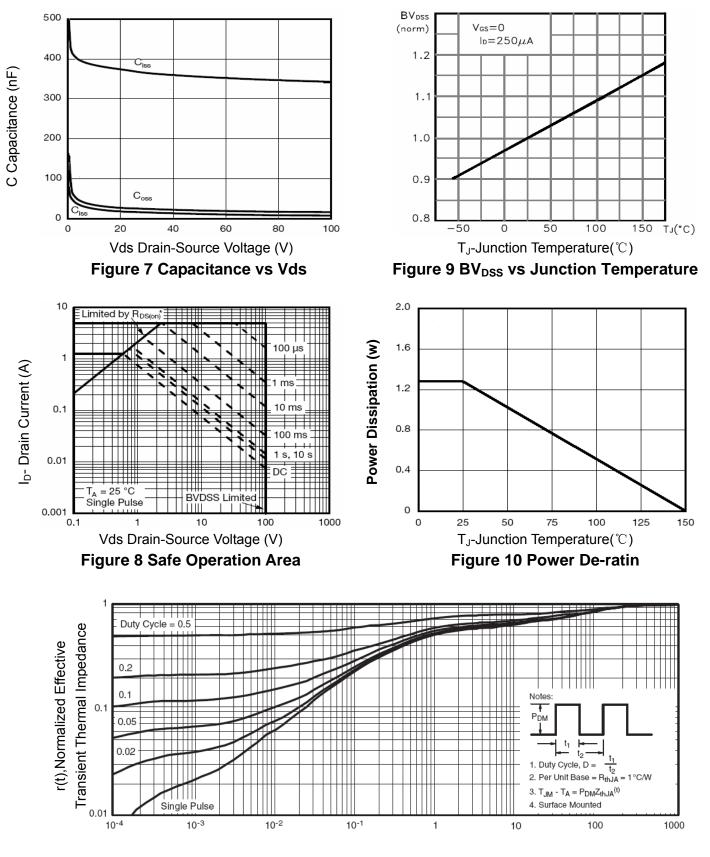




Typical Electrical and Thermal Characteristics (Curves)



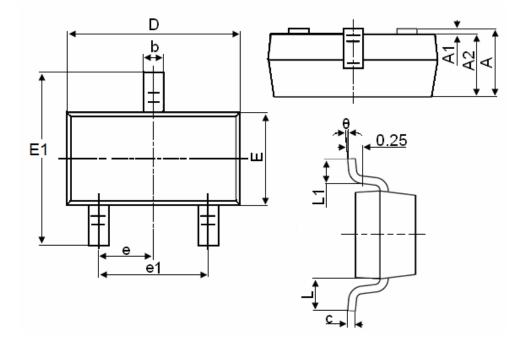




Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
A	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
с	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L	0.550REF				
L1	0.300	0.500			
θ	0°	8°			

Notes

1. All dimensions are in millimeters.

2. Tolerance ±0.10mm (4 mil) unless otherwise specified

3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.

4. Dimension L is measured in gauge plane.

5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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